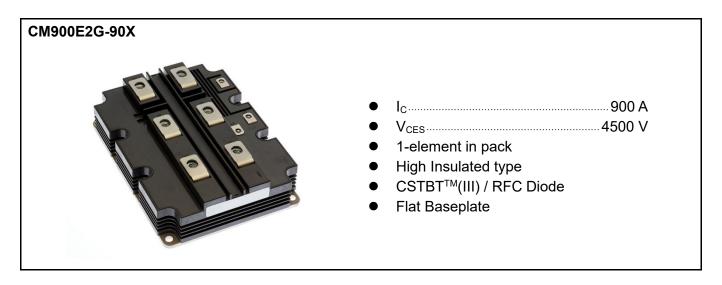


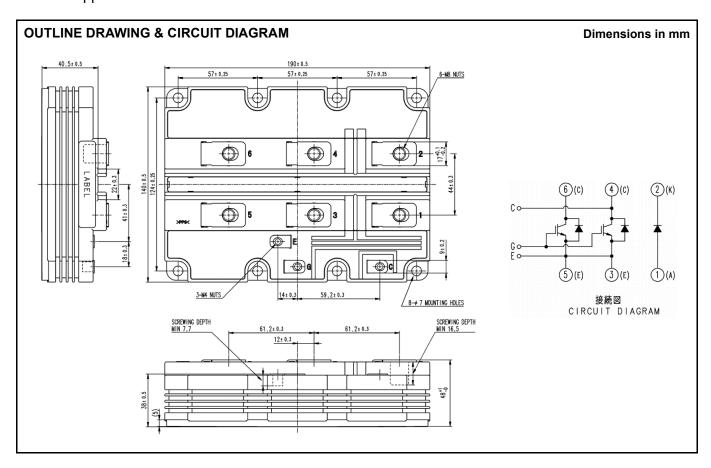
# CM900E2G-90X

HIGH POWER SWITHCHING USE INSULATED TYPE



#### **APPLICATION**

Brake chopper



# CM900E2G-90X

HIGH POWER SWITCHING USE

**INSULATED TYPE** 

### **MAXIMUM RATINGS**

Symbol	Item	Conditions	Ratings	Unit
.,	0-11	V <sub>GE</sub> = 0 V, T <sub>j</sub> = -40+150 °C	4500	V
V <sub>CES</sub>	Collector-emitter voltage	V <sub>GE</sub> = 0 V, T <sub>j</sub> = −50 °C	4400	V
V	Denetitive needs reverse voltage (Note 3)	V <sub>GE</sub> = 0 V, T <sub>j</sub> = -40+150 °C	4500	V
$V_{RRM}$	Repetitive peak reverse voltage (Note 3)	V <sub>GE</sub> = 0 V, T <sub>j</sub> = −50 °C	4400	V
V	Non repetitive peak reverse valtage (Note 3)	V <sub>GE</sub> = 0 V, T <sub>j</sub> = -40+150 °C	4500	V
$V_{RSM}$	Non-repetitive peak reverse voltage (Note 3)	$V_{GE} = 0 \text{ V}, T_j = -50 \text{ °C}$	4400	V
$V_{\text{GES}}$	Gate-emitter voltage	$V_{CE} = 0 \text{ V}, T_j = 25 \text{ °C}$	± 20	V
Ic	Collector current	DC, T <sub>c</sub> = 105 °C	900	Α
I <sub>CRM</sub>	Collector current	Pulse (Note 1)	1800	A
IE	Emitter current (Note 2)	DC, T <sub>c</sub> = 90 °C	900	^
I <sub>ERM</sub>	Emiller current (1888 2)	Pulse (Note 1)	1800	Α
I <sub>F</sub>	Forward current (Note 3)	DC, T <sub>c</sub> = 90 °C	900	^
I <sub>FRM</sub>	Forward current (************************************	Pulse (Note 1)	1800	Α
I <sub>FSM</sub>	Surge forward current (Note 3)	$T_{i \text{ start}} = 150 \text{ °C}, t_{p} = 10 \text{ms}, V_{R} = 0 \text{ V}$	8.1	kA
l <sup>2</sup> t	Surge current load integral (Note 3)	$F(\bar{t}) = 1 \%$ , Half-sine wave	328	kA <sup>2</sup> s
P <sub>tot</sub>	Maximum power dissipation (Note 4)	T <sub>c</sub> = 25 °C, IGBT part	9800	W
V <sub>iso</sub>	Isolation voltage	RMS, sinusoidal, f = 60 Hz, t = 1 min.	10200	V
Q <sub>PD</sub>	Partial discharge	Charged part to the baseplate V1 = 6900 Vrms, V2 = 5100 Vrms AC 60 Hz, T <sub>c</sub> = 25 °C (acc. to IEC 61287)	10	pC
Tj	Junction temperature	_	<b>−50 ~ +150</b>	°C
T <sub>jop</sub>	Operating junction temperature		<b>−50 ~ +150</b>	°C
T <sub>stg</sub>	Storage temperature	_	<b>−55 ~ +150</b>	°C
t <sub>psc</sub>	Short circuit pulse width	$\begin{array}{c} V_{\text{CC}} = 3400 \; \text{V}, \; V_{\text{CE}} \leq V_{\text{CES}}, \; V_{\text{GE}} = \pm 15 \; \text{V}, \; T_{j} = 150 \; ^{\circ}\text{C} \\ R_{\text{G(on)}} = 3.6 \; \Omega, \; R_{\text{G(off)}} = 45 \; \Omega, \; L_{\text{S}} \leq 225 \; \text{nH} \end{array}$	10	μs

#### **ELECTRICAL CHARACTERISTICS**

Cumbal	Item	Conditions		Limits			Unit
Symbol				Min	Тур	Max	Offic
			T <sub>j</sub> = 25 °C	_	_	4.0	
I <sub>CES</sub>	Collector cutoff current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	T <sub>j</sub> = 125 °C	_	4.0	_	mA
			T <sub>j</sub> = 150 °C	_	_	80	
$V_{GE(th)}$	Gate-emitter threshold voltage	$V_{CE} = 10 \text{ V}, I_{C} = 90 \text{ mA}, T_{j} = 25 \text{ °C}$	;	6.5	7.0	7.5	V
I <sub>GES</sub>	Gate leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = V_{GES}, T_j = 25 \text{ °C}$		-0.5	_	0.5	μΑ
C <sub>ies</sub>	Input capacitance			_	115	_	nF
C <sub>oes</sub>	Output capacitance	$V_{CE} = 10 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kH}$ $V_{I} = 25 \text{ °C}$	$V_{CE} = 10 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$		7.5	_	nF
C <sub>res</sub>	Reverse transfer capacitance	- 1j - 25 C		_	1.0	_	nF
$Q_G$	Total gate charge	$V_{CC} = 2800 \text{ V}, I_C = 900 \text{ A}, V_{GE} = \pm 15 \text{ V}, T_j = 25 ^{\circ}\text{C}$		_	8.4	_	μC
	Collector-emitter saturation voltage	I <sub>C</sub> = 900 A (Note 5) V <sub>GE</sub> = 15 V	T <sub>j</sub> = 25 °C	_	2.25	_	V
$V_{CEsat}$			T <sub>j</sub> = 125 °C	_	2.90	_	
			T <sub>j</sub> = 150 °C	_	3.00	3.50	
t <sub>d(on)</sub>	Turn-on delay time		T <sub>j</sub> = 150 °C	_	_	0.90	μs
t <sub>r</sub>	Rise time		T <sub>j</sub> = 150 °C	_	_	0.50	μs
		V <sub>cc</sub> = 2800 V	T <sub>j</sub> = 25 °C	_	4.10	_	
E <sub>on(10%)</sub>	Turn-on switching energy (Note 6)	$I_C = 900 \text{ A}$ $V_{GE} = \pm 15 \text{ V}$	T <sub>j</sub> = 125 °C	_	4.40	_	J
	per pulse	$\begin{array}{l} \text{R}_{G(\text{on})} = 3.6 \ \Omega \\ \text{L}_{\text{S}} = 225 \ \text{nH} \\ \text{Inductive load} \end{array}$	T <sub>j</sub> = 150 °C	_	4.45	_	
	Turn-on switching energy per pulse		T <sub>j</sub> = 25 °C	_	4.15	_	
E <sub>on</sub>			T <sub>j</sub> = 125 °C	_	4.60	_	J
			T <sub>j</sub> = 150 °C	_	4.65	_	

# CM900E2G-90X

HIGH POWER SWITCHING USE

**INSULATED TYPE** 

### **ELECTRICAL CHARACTERISTICS**

Symbol	Item	Conditions		Limits			Unit
Syllibol	item			Min	Тур	Max	Ullit
			T <sub>j</sub> = 25 °C	_	_	_	
$t_{\text{d(off)}}$	Turn-off delay time		T <sub>j</sub> = 125 °C	_	7.00	_	μs
			T <sub>j</sub> = 150 °C	_	7.20	10.0	
			T <sub>j</sub> = 25 °C	_	_	_	
$t_f$	Fall time	$V_{CC} = 2800 \text{ V}$ $I_{C} = 900 \text{ A}$	T <sub>j</sub> = 125 °C	_	0.50	_	μs
		V <sub>GE</sub> = ±15 V	T <sub>j</sub> = 150 °C	_	0.50	1.20	
		$R_{G(off)} = 45 \Omega$	T <sub>j</sub> = 25 °C	_	2.60	_	
E <sub>off(10%)</sub>	Turn-off switching energy (Note 6) per pulse	L <sub>S</sub> = 225 nH Inductive load	T <sub>j</sub> = 125 °C	_	3.55	_	J
	per puise	1	T <sub>j</sub> = 150 °C	_	3.75	_	
			T <sub>j</sub> = 25 °C	_	2.90	_	J
$E_{off}$	Turn-off switching energy per pulse		T <sub>j</sub> = 125 °C	_	3.95	_	
	per puise		T <sub>i</sub> = 150 °C	_	4.15	_	
	Emitter-collector voltage (Note 2)		T <sub>i</sub> = 25 °C	_	2.35	_	٧
$V_{\text{EC}}$		$I_E = 900 \text{ A}^{\text{(Note 5)}}$ $V_{GE} = 0 \text{ V}$	T <sub>i</sub> = 125 °C	_	2.90	_	
			T <sub>i</sub> = 150 °C	_	3.00	3.50	
	Reverse recovery time (Note 2)		T <sub>i</sub> = 25 °C	_	_	_	μs
t <sub>rr</sub>			T <sub>i</sub> = 125 °C	_	1.60	_	
			T <sub>i</sub> = 150 °C	_	1.85	_	
	Reverse recovery current (Note 2)	7	T <sub>i</sub> = 25 °C	_	_	_	А
Irr			T <sub>i</sub> = 125 °C	_	1300	_	
			T <sub>i</sub> = 150 °C	_	1300	_	
	Reverse recovery charge (Note 2.7)		T <sub>i</sub> = 25 °C	_	_	_	μC
Q <sub>rr(10%)</sub>		V <sub>CC</sub> = 2800 V	T <sub>i</sub> = 125 °C	_	1830	_	
		I <sub>E</sub> = 900 A V <sub>GE</sub> = ±15 V	T <sub>i</sub> = 150 °C	_	1870	_	
		$R_{G(on)} = 3.6 \Omega$	T <sub>i</sub> = 25 °C	_	_	_	
$Q_{rr}$	Reverse recovery charge (Note 2)	L <sub>S</sub> = 225 nH Inductive load	T <sub>i</sub> = 125 °C	_	1910	_	μC
		maddive load	T <sub>i</sub> = 150 °C	_	1930	_	
			T <sub>i</sub> = 25 °C	_	2.30	_	
E <sub>rec(10%)</sub>	Reverse recovery energy (Note 2,6) per pulse		T <sub>i</sub> = 125 °C	_	3.00	_	J
·/			T <sub>i</sub> = 150 °C	_	3.10	_	
		7	T <sub>i</sub> = 25 °C	_	2.35	_	
E <sub>rec</sub>	Reverse recovery energy (Note 2)		T <sub>i</sub> = 125 °C	_	3.20	_	J
	per pulse		T <sub>i</sub> = 150 °C	_	3.25	_	

# CM900E2G-90X

## HIGH POWER SWITCHING USE

**INSULATED TYPE** 

#### **ELECTRICAL CHARACTERISTICS**

Cumbal	ltem	Conditions		Limits			Unit
Symbol				Min	Тур	Max	Unit
			T <sub>j</sub> = 25 °C	_	_	1.6	
$I_{RRM}$	Repetitive reverse current (Note 3)	$V_{AK} = V_{RRM}$	T <sub>j</sub> = 125 °C	_	1.6	_	mA
			T <sub>j</sub> = 150 °C	_	_	32	
			T <sub>j</sub> = 25 °C	_	2.35	_	
$V_{F}$	Forward voltage (Note 3)	I <sub>F</sub> = 900 A (Note 5)	T <sub>j</sub> = 125 °C	_	2.90	_	V
			T <sub>j</sub> = 150 °C	_	3.00	3.50	
			T <sub>j</sub> = 25 °C	_	_	_	
t <sub>rr</sub>	Reverse recovery time (Note 3)		T <sub>j</sub> = 125 °C	_	1.60	_	μs
			T <sub>j</sub> = 150 °C	_	1.85	_	
	Reverse recovery current (Note 3)	$V_{CC}$ = 2800 V $I_F$ = 900 A $-di_F/dt \cong$ 3000 A/µs @ $T_j$ = 25 °C 2800 A/µs @ $T_j$ = 125 °C 2700 A/µs @ $T_j$ = 150 °C $L_S$ = 225 nH Inductive load	T <sub>j</sub> = 25 °C	_	_	_	А
Irr			T <sub>j</sub> = 125 °C	_	1300	_	
			T <sub>j</sub> = 150 °C	_	1300	_	
	Reverse recovery charge (Note 3.7)		T <sub>j</sub> = 25 °C	_	_	_	μC
Q <sub>rr(10%)</sub>			T <sub>j</sub> = 125 °C	_	1830	_	
			T <sub>j</sub> = 150 °C	_	1870	_	
	Reverse recovery charge (Note 3)		T <sub>j</sub> = 25 °C	_	_	_	
$Q_{rr}$			T <sub>j</sub> = 125 °C	_	1910	_	
			T <sub>j</sub> = 150 °C	_	1930	_	
	(Note 2.5)		T <sub>j</sub> = 25 °C	_	2.30	_	
E <sub>rec(10%)</sub>	Reverse recovery energy (Note 3,6) per pulse		T <sub>j</sub> = 125 °C	_	3.00	_	J
			T <sub>j</sub> = 150 °C	_	3.10	_	
	- (41.1.0)		T <sub>j</sub> = 25 °C	_	2.35	_	
$E_{rec}$	Reverse recovery energy (Note 3)		T <sub>j</sub> = 125 °C	_	3.20	_	J
	per pulse		T <sub>i</sub> = 150 °C	_	3.25	_	

## CM900E2G-90X

## **HIGH POWER SWITCHING USE**

**INSULATED TYPE** 

#### THERMAL CHARACTERISTICS

Cymhal	Item	Conditions	Limits			Unit
Symbol		Conditions		Тур	Max	Uill
R <sub>th(j-c)Q</sub>	Thermal resistance	Junction to Case, IGBT part	_	_	12.8	K/kW
R <sub>th(j-c)D</sub>	Thermal resistance (Note 2)	Junction to Case, FWDi part	_	_	19.5	K/kW
R <sub>th(j-c)D</sub>	Thermal resistance (Note 3)	Junction to Case, Clamp-Di part			19.5	K/kW
R <sub>th(c-s)</sub>	Contact thermal resistance (Note 2)	Case to heat sink, Switching part $\lambda_{\text{grease}}$ = 1W/m·k, D <sub>(c-s)</sub> = 80 µm	-	7.5	-	K/kW
R <sub>th(c-s)</sub>	Contact thermal resistance (Note 3)	Case to heat sink, Clamp-Di part $\lambda_{\text{grease}}$ = 1 W/m·K, D <sub>(c-s)</sub> = 80 µm	_	15.0	_	K/kW

#### **MECHANICAL CHARACTERISTICS**

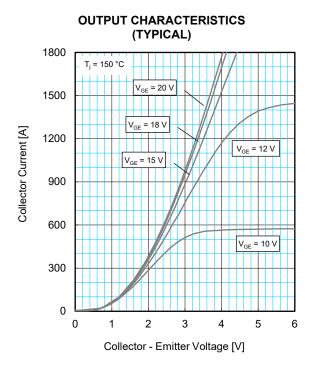
Comple al	Item	Conditions	Limits			Unit
Symbol		Conditions		Тур	Max	Offic
Mt		M8 : Main terminals screw	7.0	_	19.0	N·m
Ms	Mounting torque	M6 : Mounting screw	3.0	-	6.0	N·m
$M_t$		M4 : Auxiliary terminals screw	1.0	_	3.0	N·m
М	Mass		_	1.5	_	kg
CTI	Comparative tracking index		600	_	_	_
d <sub>a</sub>	Clearance		26.0	_	_	mm
d <sub>s</sub>	Creepage distance		56.0	_	_	mm
L <sub>P(C-E)</sub>		Collector to Emitter	_	20.5	_	nΗ
L <sub>P(A-K)</sub>	Internal inductance	Anode to Cathode	_	41.0	_	nΗ
R <sub>CC'+EE'</sub>	Internal lead resistance	T <sub>C</sub> = 25 °C, Collector to Emitter	_	0.18	_	mΩ
R <sub>AA'+KK'</sub>	IIILEITIAI IEAU TESISLAIICE	T <sub>C</sub> = 25 °C, Anode to Cathode	_	0.36	_	mΩ

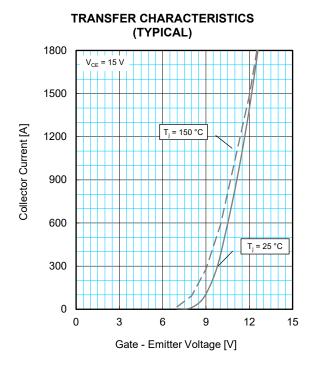
- Note 1. Pulse width and repetition rate should be such that junction temperature  $(T_j)$  does not exceed  $T_{jopmax}$  rating.
- Note 2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWD<sub>i</sub>).
- Note 3. The symbols represent characteristics of the clamp diode (Clamp-Di).
- Note 4. Junction temperature (T<sub>j</sub>) should not exceed T<sub>jmax</sub> rating (150°C).
- Note 5. Pulse width and repetition rate should be such as to cause negligible temperature rise.
- Note 6. The integration range of switching energies is from  $10\%V_{CE}$  to  $10\%I_{C}(10\%I_{E})$ .
- Note 7. The integration range of reverse recovery charge is from  $I_E$  = 0A to 10% $I_E$ .

**HIGH POWER SWITCHING USE** 

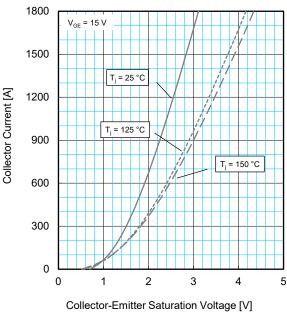
**INSULATED TYPE** 

#### **PERFORMANCE CURVES**

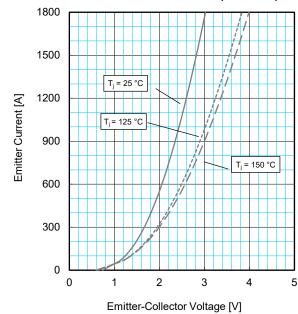




# COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



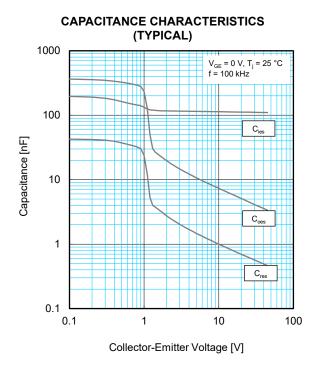
# FREE-WHEEL DIODE / CLAMP DIODE FORWARD CHARACTERISTICS (TYPICAL)

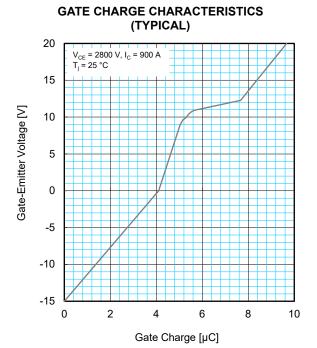


**HIGH POWER SWITCHING USE** 

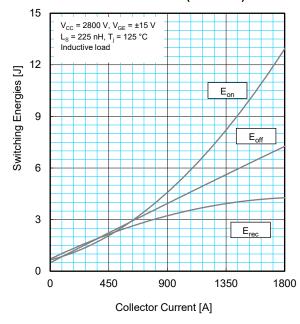
**INSULATED TYPE** 

#### **PERFORMANCE CURVES**

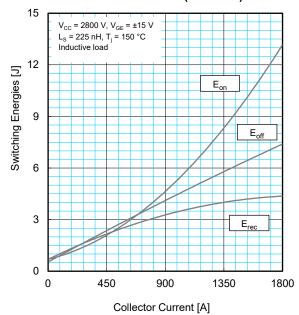




#### HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



#### HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

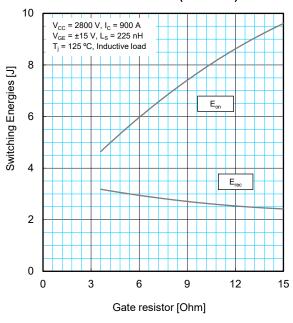


**HIGH POWER SWITCHING USE** 

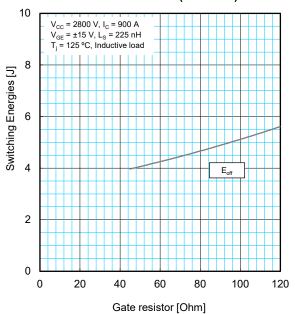
**INSULATED TYPE** 

#### **PERFORMANCE CURVES**

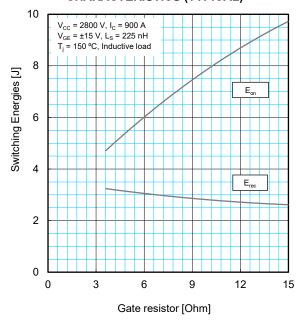
# HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



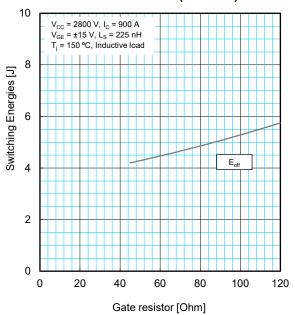
#### HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



#### HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



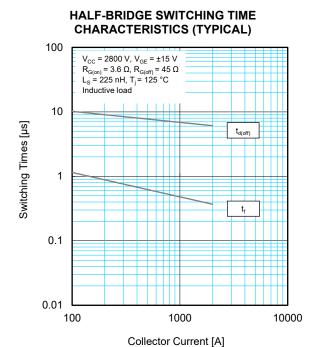
#### HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)

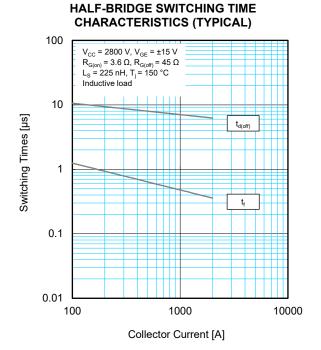


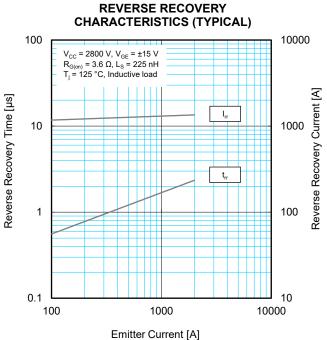
**HIGH POWER SWITCHING USE** 

**INSULATED TYPE** 

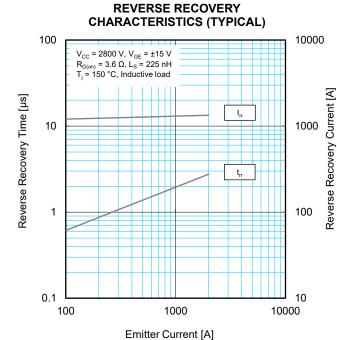
#### **PERFORMANCE CURVES**







FREE-WHEEL DIODE / CLAMP DIODE



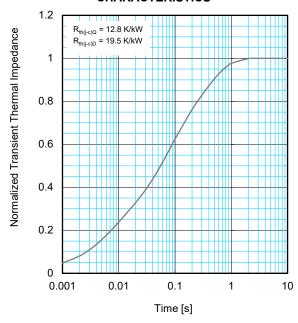
FREE-WHEEL DIODE / CLAMP DIODE

**HIGH POWER SWITCHING USE** 

**INSULATED TYPE** 

#### **PERFORMANCE CURVES**

# TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



$$Z_{th(j-c)}(t) = \sum_{i=1}^{n} R_{i} \left\{ 1 - \exp^{\left(-\frac{t}{\tau_{i}}\right)} \right\}$$

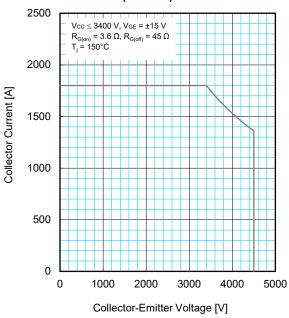
	1	2	3	4
$R_i/R_{th}$ :	0.0096	0.1893	0.4044	0.3967
τ <sub>i</sub> [sec.] :	0.0001	0.0058	0.0602	0.3512

**HIGH POWER SWITCHING USE** 

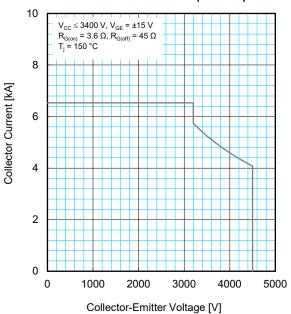
**INSULATED TYPE** 

#### **PERFORMANCE CURVES**

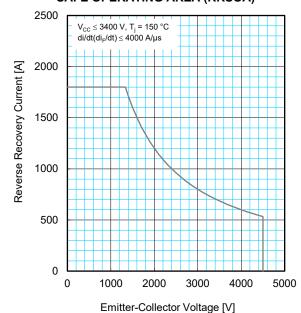
# REVERSE BIAS SAFE OPERATING AREA (RBSOA)



# SHORT CIRCUIT SAFE OPERATING AREA (SCSOA)



#### FREE-WHEEL DIODE / CLAMP DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)



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HIGH POWER SWITCHING USE
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## **Important Notice**

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HIGH POWER SWITCHING USE
INSULATED TYPE

## Keep safety first in your circuit designs!

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